

# 2SK3693-01MR

**FUJI**  
**ELECTRIC**

200305

## FUJI POWER MOSFET Super FAP-G Series

### ■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

### ■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

### ■ Maximum ratings and characteristic

#### ● (Tc=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit
Drain-source voltage	VDS	450	V
	VDSX *5	450	V
Continuous drain current	Id	±17	A
Pulsed drain current	Id(puls)	±68	A
Gate-source voltage	VGS	±30	V
Repetitive or non-repetitive	IAR *2	17	A
Maximum Avalanche Energy	EAS *1	221.9	mJ
Maximum Drain-Source dV/dt	dVds/dt *4	20	kV/μs
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs
Max. power dissipation	Pd	2.16	W
	Ta=25°C		
	Tc=25°C	80	
Operating and storage temperature range	Tch	+150	°C
	Tstg	-55 to +150	°C
Isolation Voltage	Viso *6	2000	V

\*1 L=1.41mH, Vcc=45V, Tch=25°C See to Avalanche Energy Graph \*2 Tch ≤ 150°C

\*3 If ≤ -Id, -di/dt=50A/μs, Vcc≤BVdss, Tch≤150°C \*4 VDS≤450V \*5 VGS=-30V \*6 f=6-Hz, t=60sec.

#### ● Electrical characteristics (Tc = 25°C unless otherwise specified)

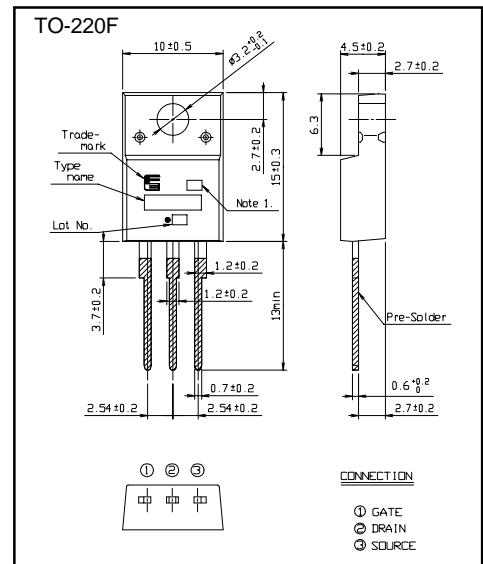
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id= 250μA VGS=0V	450			V
Gate threshold voltage	VGS(th)	Id= 250μA VDS=VGS	3.0		5.0	V
Zero gate voltage drain current	Idss	VDS=450V VGS=0V			25	μA
		VDS=360V VGS=0V			250	
Gate-source leakage current	IGSS	VGS=±30V VDS=0V			100	nA
Drain-source on-state resistance	RDS(on)	Id=8.5A VGS=10V		0.29	0.38	Ω
Forward transconductance	gfs	Id=8.5A VDS=25V	7	14		S
Input capacitance	Ciss	VDS=25V		1275	1900	pF
Output capacitance	Coss	VGS=0V		200	300	
Reverse transfer capacitance	Crss	f=1MHz		9.5	14	
Turn-on time ton	td(on)	Vcc=300V Id=8.5A		27	40	ns
	tr	VGS=10V		27	40	
Turn-off time toff	td(off)	Rgs=10Ω		48	72	
	tf			7	11	
Total Gate Charge	QG	Vcc=225V		33	50	nC
Gate-Source Charge	QGS	Id=17A		13.5	20.3	
Gate-Drain Charge	QGD	VGS=10V		10.5	16	
Avalanche capability	IAV	L=1.41mH Tch=25°C	17			A
Diode forward on-voltage	VSD	If=17A VGS=0V Tch=25°C		1.20	1.80	V
Reverse recovery time	trr	If=17A VGS=0V		0.57		μs
		-di/dt=100A/μs Tch=25°C		6.5		μC

#### ● Thermal characteristics

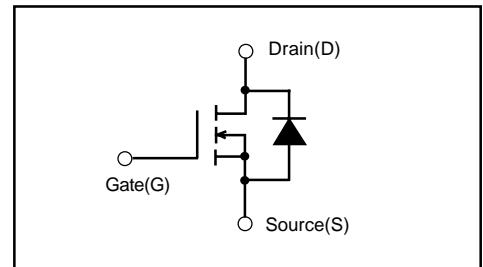
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			1.563	°C/W
	Rth(ch-a)	channel to ambient			58.0	°C/W

### N-CHANNEL SILICON POWER MOSFET

### ■ Outline Drawings [mm]



### ■ Equivalent circuit schematic



## ■ Characteristics

